



flowPACK 1 SiC

1200 V / 42 mΩ

Topology features

- 3xHalf Bridge
- Open Emitter configuration
- Kelvin Emitter for improved switching performance
- Temperature sensor

Component features

- High Blocking Voltage with low drain source on state resistance
- High speed SiC-MOSFET technology
- Resistant to Latch-up

Housing features

- Base isolation: Al<sub>2</sub>O<sub>3</sub>
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Solder pin

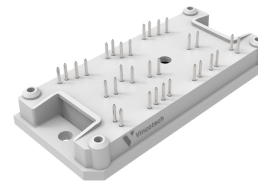
Target applications

- Elevator Drives

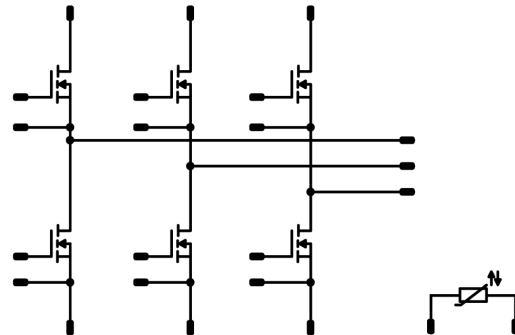
Types

- 10-FY126PA042ME-L226F68

flow 1 12 mm housing



Schematic





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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Inverter Switch</b>				
Drain-source voltage	$V_{DS}$		1200	V
Drain current (DC current)	$I_D$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	26	A
Peak drain current	$I_{DM}$	$t_p$ limited by $T_{jmax}$	104	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	W
Gate-source voltage	$V_{GS}$		-4 / 15	V
		dynamic	-8 / 19	
Maximum Junction Temperature	$T_{jmax}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Creepage distance			>12,7	mm
Clearance			12,12	mm
Comparative Tracking Index	CTI		≥ 600	

\*100 % tested in production



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Inverter Switch

##### Static

Drain-source on-state resistance	$r_{DS(on)}$		15		25,8	25 125 150	29,4	46,1 65,6 73,8	54,6 <sup>(1)</sup>	mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$			0,00711	25	1,8	2,7	3,6	V
Gate to Source Leakage Current	$I_{GSS}$		15	0		25		10	250	nA
Zero Gate Voltage Drain Current	$I_{DSS}$		0	1200		25		1	50	μA
Internal gate resistance	$r_g$							5,9		Ω
Gate charge	$Q_g$		-4/15	800	25,8	25		93		nC
Short-circuit input capacitance	$C_{iss}$	$f = 100$ kHz	0	1000	0	25		2370		pF
Short-circuit output capacitance	$C_{oss}$							85		
Reverse transfer capacitance	$C_{rss}$							8		
Diode forward voltage	$V_{SD}$		0		12,9	25		4,8		V

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,85		K/W
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10-FY126PA042ME-L226F68  
datasheet

### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit				
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max						
<b>Dynamic</b>														
Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16 \Omega$ $R_{goff} = 16 \Omega$	-4/15	600	32	25		37,09		ns				
						125		32,84						
						150		32,56						
Rise time	$t_r$					25		20,49						
						125		18,63		ns				
						150		18,07						
Turn-off delay time	$t_{d(off)}$					25		97,98						
						125		106,72		ns				
						150		109,16						
Fall time	$t_f$					25		9,27						
						125		9,15		ns				
						150		9,53						
Turn-on energy (per pulse)	$E_{on}$					$Q_{rFWD}=0,125 \mu C$ $Q_{rFWD}=0,36 \mu C$ $Q_{rFWD}=0,468 \mu C$				25		0,779		mWs
										125		0,749		
										150		0,778		
Turn-off energy (per pulse)	$E_{off}$					25		0,239						
						125		0,239		mWs				
						150		0,24						
Peak recovery current	$I_{RRM}$					25		14,62		A				
						125		17,83						
						150		19,55						
Reverse recovery time	$t_{rr}$					25		14,69						
						125		50,26		ns				
						150		50,87						
Recovered charge	$Q_r$	$di/dt=1839 A/\mu s$ $di/dt=2111 A/\mu s$ $di/dt=1890 A/\mu s$				25		0,125		$\mu C$				
						125		0,36						
						150		0,468						
Reverse recovered energy	$E_{rec}$					25		$6,964 \times 10^{-3}$						
						125		0,082		mWs				
						150		0,113						
Peak rate of fall of recovery current	$(di/dt)_{max}$					25		3317						
						125		1931,79		A/ $\mu s$				
						150		1149,14						



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$V_{CE}$ [V]	$I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of R100	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.

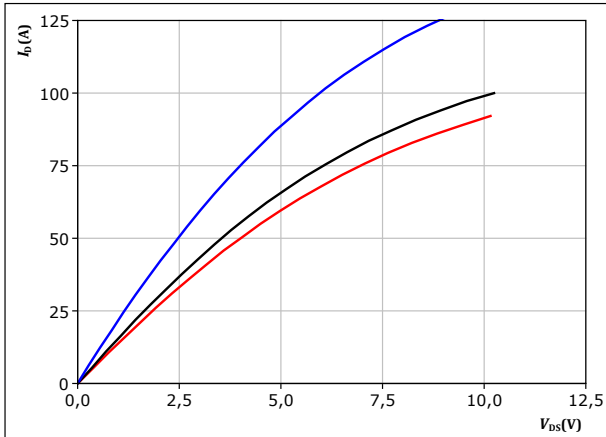


## Inverter Switch Characteristics

figure 1. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$



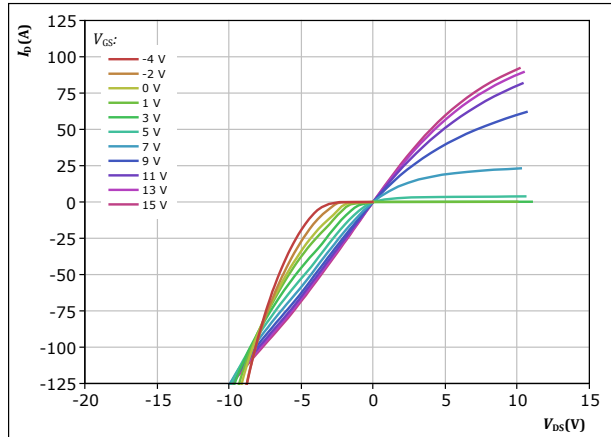
$t_p = 250 \mu s$   
 $V_{GS} = 15 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 2. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

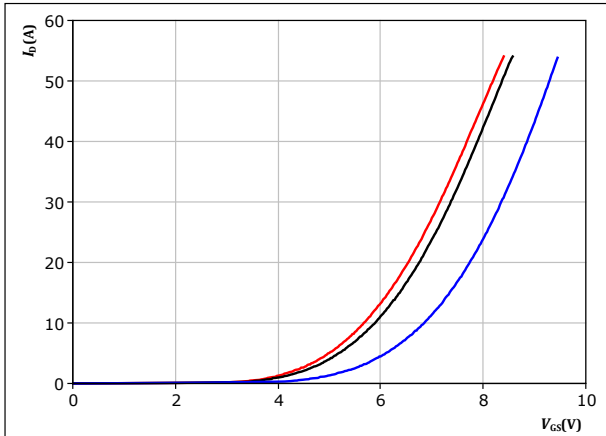


$t_p = 250 \mu s$   
 $T_j = 150 \text{ °C}$   
 $V_{GS}$  from -4 V to 15 V in steps of 2 V

figure 3. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$



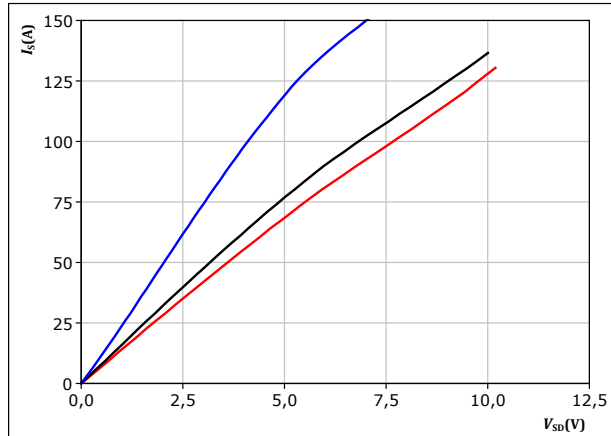
$t_p = 250 \mu s$   
 $V_{DS} = 10 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 4. MOSFET

Typical reverse drain current characteristics

$$I_{SD} = f(V_{SD})$$



$t_p = 250 \mu s$   
 $V_{GS} = 15 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

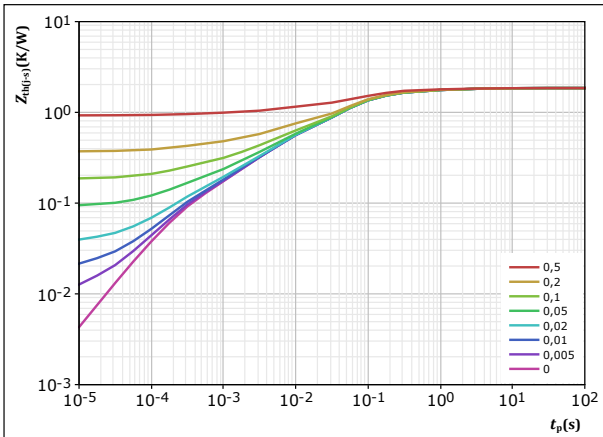


## Inverter Switch Characteristics

**figure 5.** MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$$D = t_p / T$$

$$R_{th(j-s)} = 1,852 \text{ K/W}$$

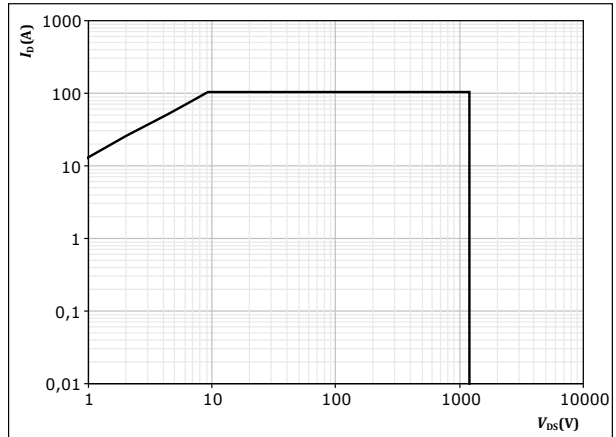
MOSFET thermal model values

R (K/W)	$\tau$ (s)
7,00E-02	4,35E+00
2,34E-01	5,16E-01
1,12E+00	6,38E-02
3,39E-01	4,30E-03
8,83E-02	2,60E-04

**figure 6.** MOSFET

Safe operating area

$$I_D = f(V_{DS})$$



D = single pulse

$$T_s = 80 \text{ } ^\circ\text{C}$$

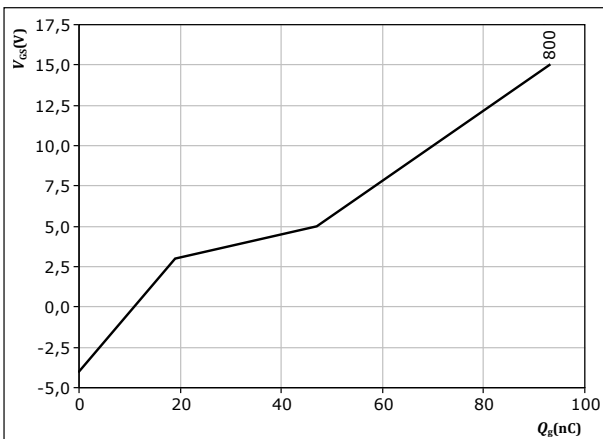
$$V_{GS} = 15 \text{ V}$$

$$T_j = T_{jmax}$$

**figure 7.** MOSFET

Gate voltage vs gate charge

$$V_{GS} = f(Q_g)$$



$$I_D = 25.8 \text{ A}$$

$$T_j = 25 \text{ } ^\circ\text{C}$$

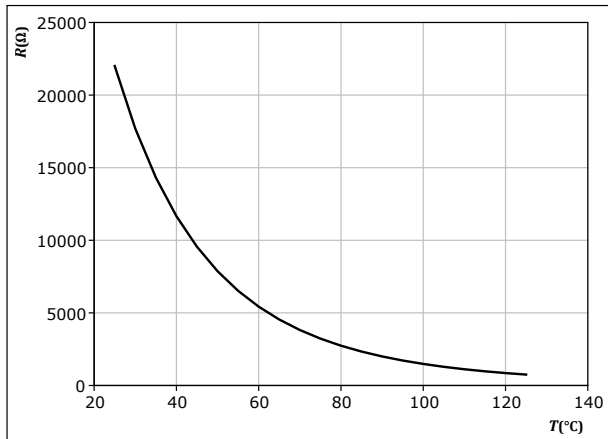


## Thermistor Characteristics

figure 8. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$



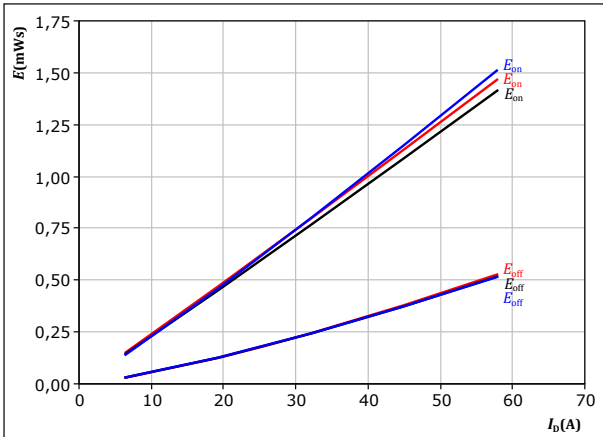




## Inverter Switching Characteristics

**figure 9.** MOSFET

Typical switching energy losses as a function of drain current  
 $E = f(I_D)$

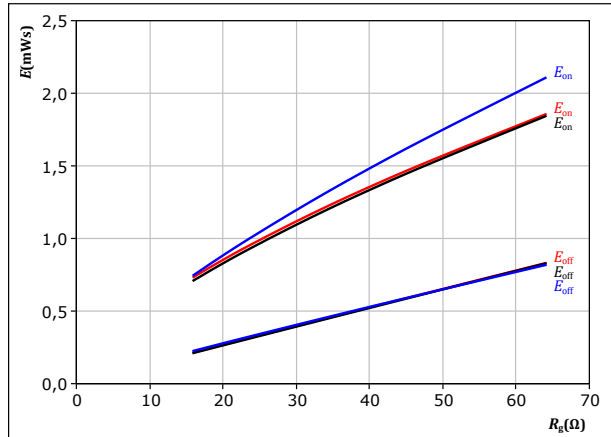


With an inductive load at

$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$R_{gon} =$	16	$\Omega$		150 °C
$R_{goff} =$	16	$\Omega$		

**figure 10.** MOSFET

Typical switching energy losses as a function of MOSFET turn on gate resistor  
 $E = f(R_g)$

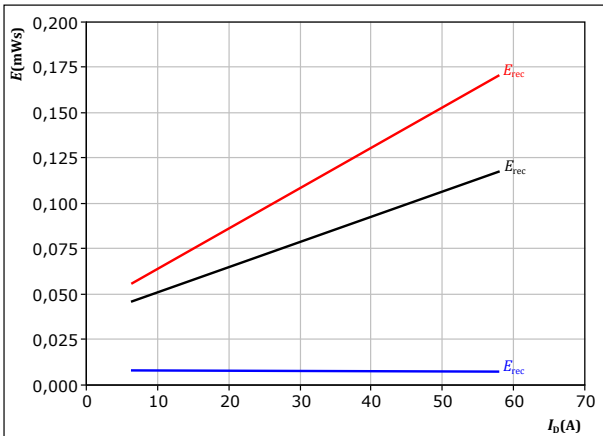


With an inductive load at

$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$I_D =$	32	A		150 °C

**figure 11.** MOSFET

Typical reverse recovered energy loss as a function of drain current  
 $E_{rec} = f(I_D)$

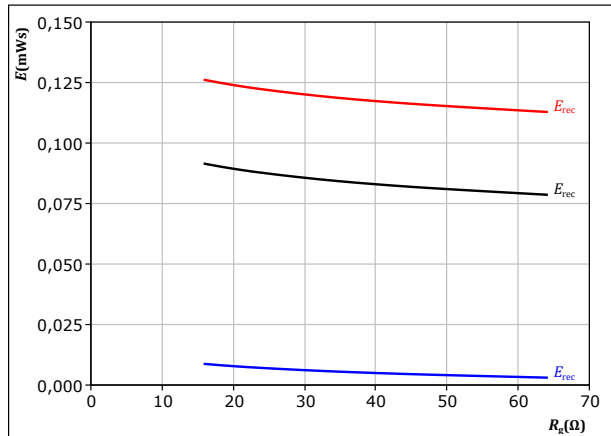


With an inductive load at

$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$R_{gon} =$	16	$\Omega$		150 °C

**figure 12.** MOSFET

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

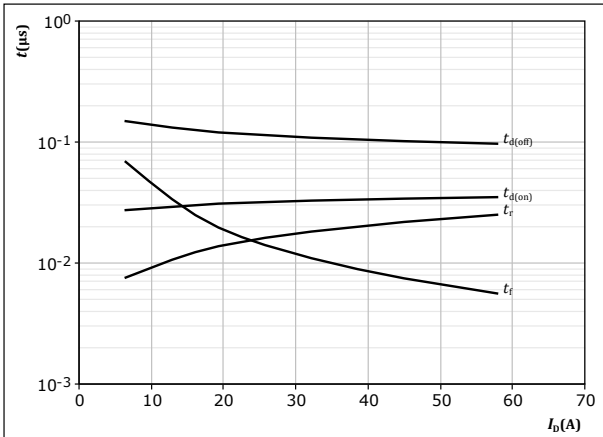
$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$I_D =$	32	A		150 °C



## Inverter Switching Characteristics

**figure 13.** MOSFET

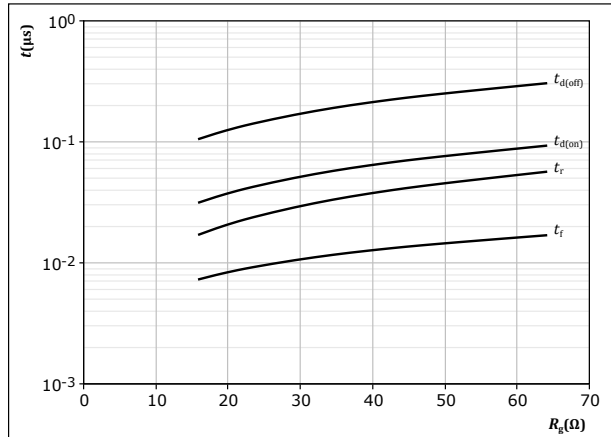
Typical switching times as a function of drain current  
 $t = f(I_D)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{DS} = 600 \text{ V}$   
 $V_{GS} = -4/15 \text{ V}$   
 $R_{gon} = 16 \text{ } \Omega$   
 $R_{goff} = 16 \text{ } \Omega$

**figure 14.** MOSFET

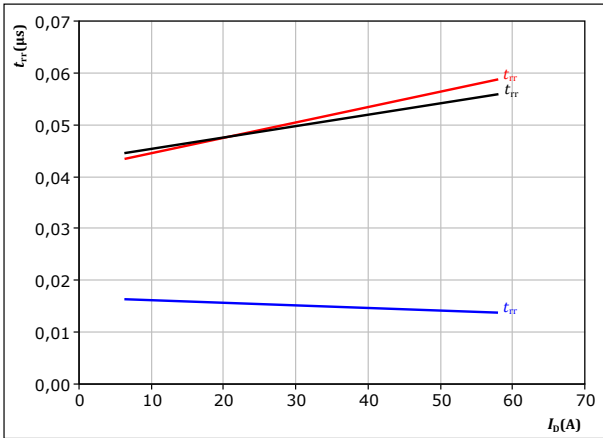
Typical switching times as a function of MOSFET turn on gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{DS} = 600 \text{ V}$   
 $V_{GS} = -4/15 \text{ V}$   
 $I_D = 32 \text{ A}$

**figure 15.** MOSFET

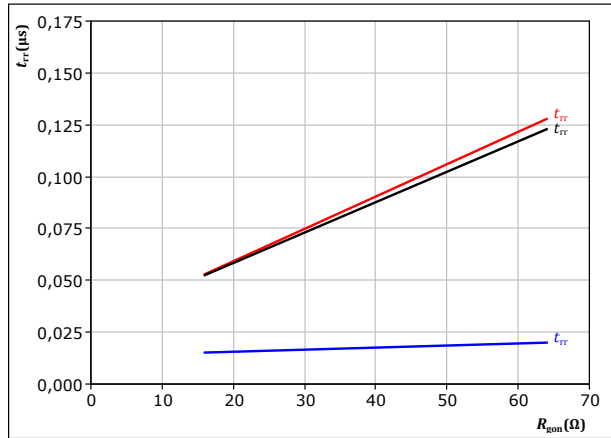
Typical reverse recovery time as a function of drain current  
 $t_{rr} = f(I_D)$



At  $V_{DS} = 600 \text{ V}$   
 $V_{GS} = -4/15 \text{ V}$   
 $R_{gon} = 16 \text{ } \Omega$   
 $T_j$ : — 25 °C  
— 125 °C  
— 150 °C

**figure 16.** MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor  
 $t_{rr} = f(R_{gon})$



At  $V_{DS} = 600 \text{ V}$   
 $V_{GS} = -4/15 \text{ V}$   
 $I_D = 32 \text{ A}$   
 $T_j$ : — 25 °C  
— 125 °C  
— 150 °C

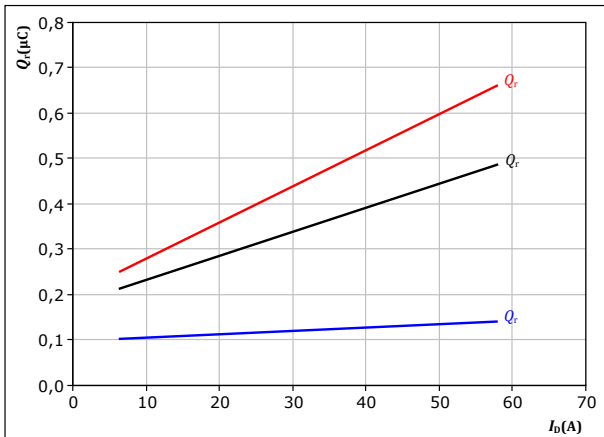


## Inverter Switching Characteristics

**figure 17.** MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$

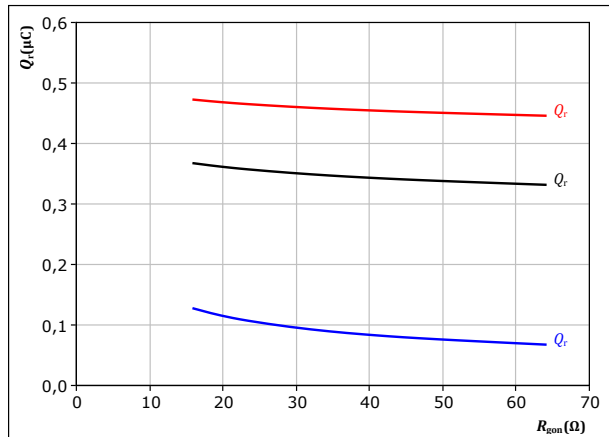


At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{g\text{on}} = 16$  Ω  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 18.** MOSFET

Typical recovered charge as a function of MOSFET turn on gate resistor

$$Q_r = f(R_{g\text{on}})$$

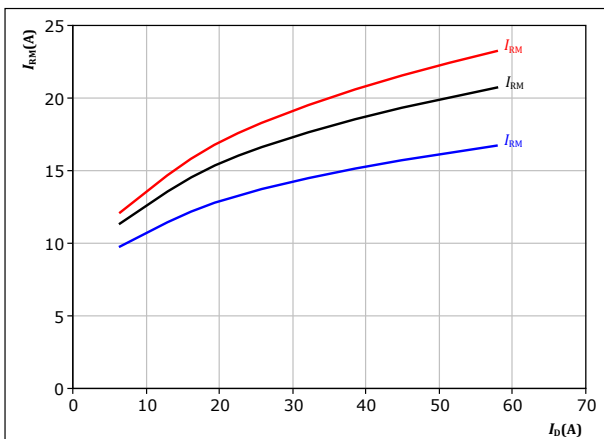


At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 32$  A  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 19.** MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$

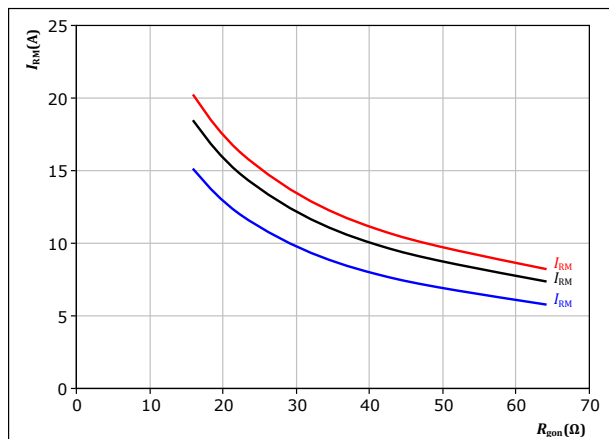


At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{g\text{on}} = 16$  Ω  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 20.** MOSFET

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RM} = f(R_{g\text{on}})$$



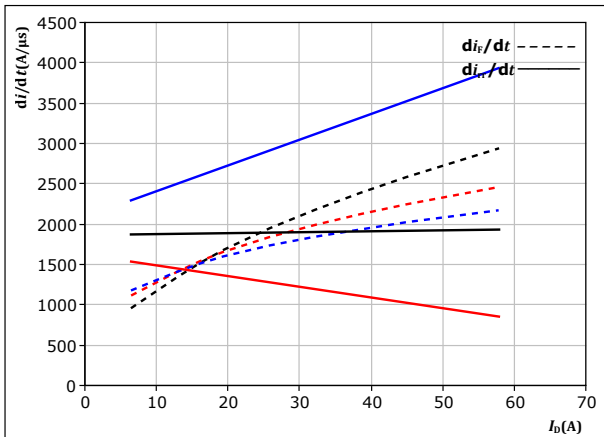
At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 32$  A  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)



## Inverter Switching Characteristics

**figure 21.** MOSFET

Typical rate of fall of forward and reverse recovery current as a function of drain current  
 $di_f/dt, di_r/dt = f(I_D)$

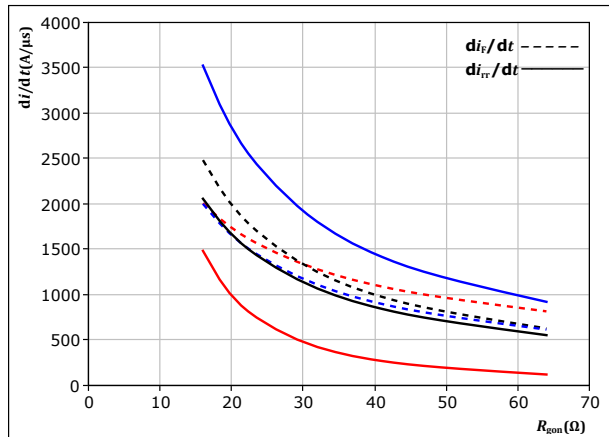


At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{g(on)} = 16$   $\Omega$

$T_j = 25$  °C  
 $T_j = 125$  °C  
 $T_j = 150$  °C

**figure 22.** MOSFET

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_r/dt = f(R_{g(on)})$



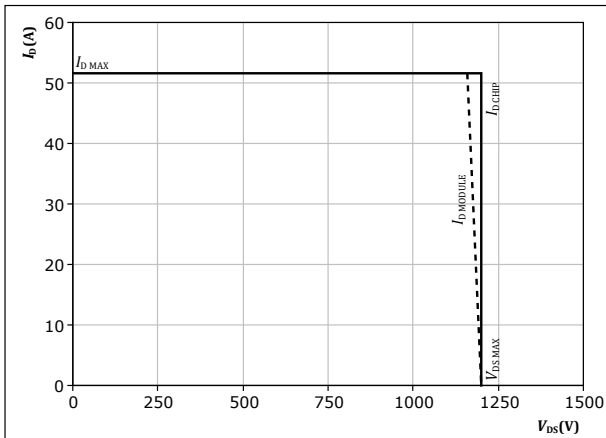
At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 32$  A

$T_j = 25$  °C  
 $T_j = 125$  °C  
 $T_j = 150$  °C

**figure 23.** MOSFET

Reverse bias safe operating area

$I_D = f(V_{DS})$



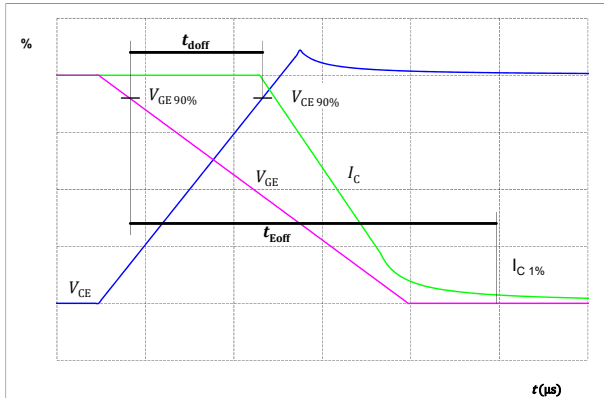
At  $T_j = 150$  °C  
 $R_{g(on)} = 16$   $\Omega$   
 $R_{g(off)} = 16$   $\Omega$



## Inverter Switching Definitions

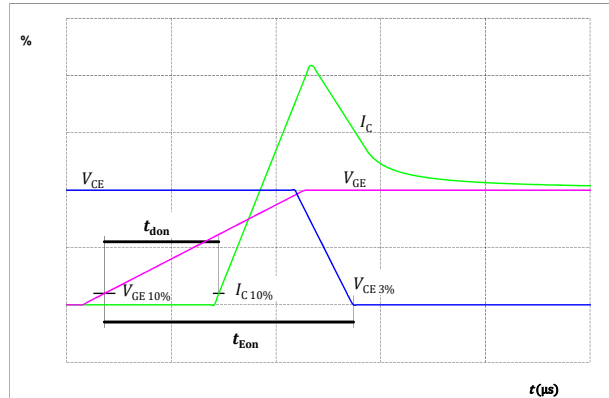
**figure 24.** MOSFET

Turn-off Switching Waveforms & definition of  $t_{doff}$   $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



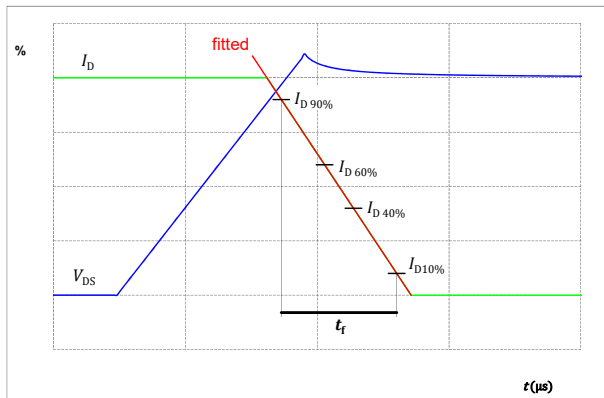
**figure 25.** MOSFET

Turn-on Switching Waveforms & definition of  $t_{don}$   $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



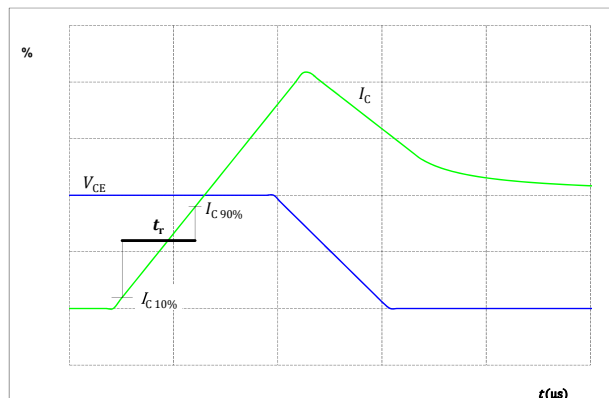
**figure 26.** MOSFET

Turn-off Switching Waveforms & definition of  $t_f$



**figure 27.** MOSFET

Turn-on Switching Waveforms & definition of  $t_r$





### Inverter Switching Definitions

figure 28. FWD

Turn-off Switching Waveforms & definition of  $t_{tr}$

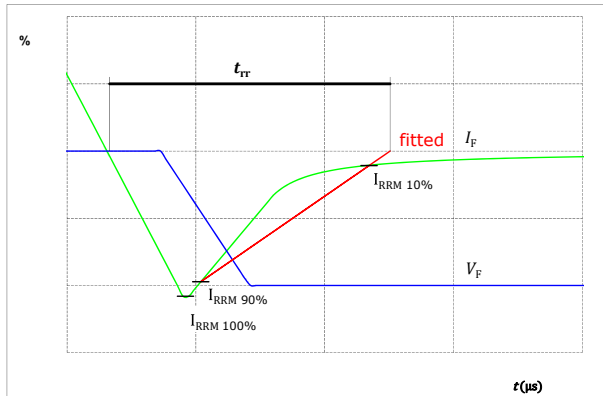


figure 29. FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )

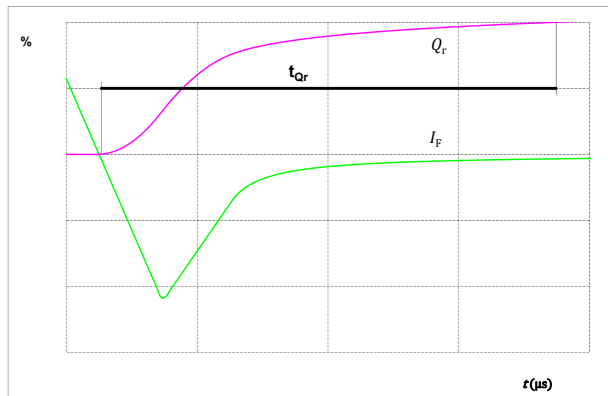
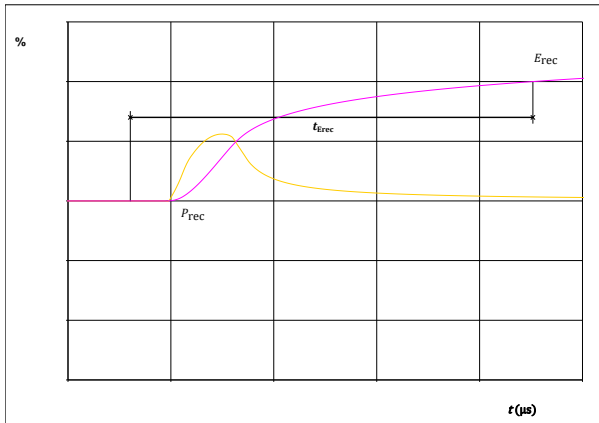


figure 30. FWD

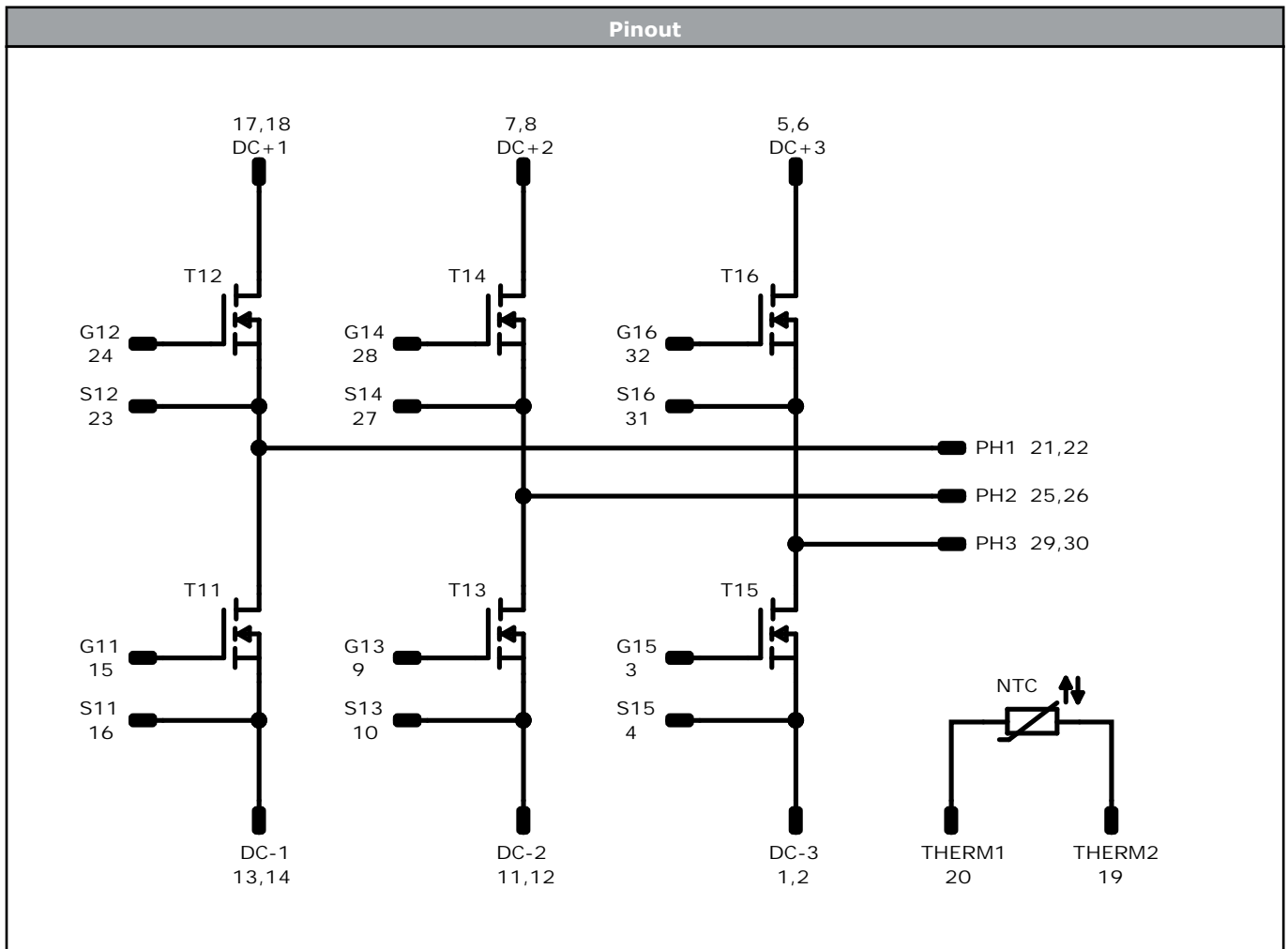
Turn-on Switching Waveforms & definition of  $t_{Erec}$  ( $t_{Erec}$  = integrating time for  $E_{rec}$ )







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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	MOSFET	1200 V	42 mΩ	Inverter Switch	
Rt	Thermistor			Thermistor	





Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> 1 packages see vincotech.com website.

Package data
Package data for <i>flow</i> 1 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=175^{\circ}C$ and up to 3500VAC/1min isolation voltage. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-FY126PA042ME-L226F68-D1-14	30 Apr. 2024		

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Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.